



CKT	DIM A	DIM B	DIM C
2	2.00	8.00	4.75
3	4.00	10.00	6.75
4	6.00	12.00	8.75
5	8.00	14.00	10.75
6	10.00	16.00	12.75
7	12.00	18.00	14.75

NOTES:

1. MATERIAL:

1.1 HOUSING: HALOGEN FREE PLASTIC, HIGH TEMP., PA9T,WHITE,UL94V-0;

1.2 CONTACT: BRASS C2680

1.3 FITTING NAIL: BRASS C2680

2. FINISH:

2.1 TERMINA FINISH :

N: 80u"MIN MATT TIN ON CONTACT AND SOLDER AREA.

50~100u" NICKEL UNDERPLATING OVERALL.

A: 3u"MIN GOLD ON CONTACT AND G/F SOLDER AREA.

50u"MIN NICKEL UNDERPLATING OVERALL.

2.2 FITTING NAIL FINISH:

N: 80u"MIN MATT TIN PLATEING OVERALL

50u" MIN NICKEL UNDERP LATING OVERALL.

3. REFLOW SOLDER CAPABLE TO 260°C

PER ACES SPEC.

4. SPEC. PLS. REFER TO PS-51206-xxxxx-xxx

5. PACKAGE PLS. REFER TO 51313-xxxxx-xx-TRP

51313-XXX X X -XXX

No Of Contact

001: Natural

Packing

Plating

O:Tape & Reel

N: Matt Tin

A: 3u" Gold on contact

g/f on solder area

QUALITY SYMBOLS		DRAWN BY	DATE	ACES ELECTRONICS
MAJOR	Ⓜ	Ding,shuqin	22/04/16	
CRITICAL	Ⓢ	CHECKED BY	DATE	TITLE
GENERAL TOLERANCES (UNLESS SPECIFIED)		Lu, jing quan	22/04/16	
X	±0.5	APPROVED BY	DATE	SMT R/A S/R TYPE
.X	±0.25	hsieh,fu yu	22/04/16	UNITS
.XX	±0.15	SCALE		mm
.XXX	±0.1	SHEET NO.		2:1
ANGLES	±2°	REV		1 OF 1
		SIZE	RFQ NO.	A4
		DWG NO.		NA
		51313-xxxxx-xxx		